

TRANSLATION

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February 2, 2012

Company name: SUMCO Corporation
Representative: Yoichi Taguchi, President
(Code: 3436, TSE First Section)
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Request for Subscription of Preferred Shares

SUMCO Corporation (the “Company”) decided to request companies including Sumitomo Metal Industries, Ltd. (“Sumitomo Metal Industries”) and Mitsubishi Materials Corporation (“Mitsubishi Materials”) to subscribe 45.0 billion yen of the shares of preferred stock (the “Preferred Shares”) at a meeting of its board of directors held on February 2, 2012.

1. Purpose

The Company announced today the Business Reorganization Plan (the “Plan”) to enhance profitability in order to enable profit generation even during difficult business environment. The key measures of the Plan are as followings:

- Withdrawal from the solar silicon wafer business
- Restructuring and consolidation of the semiconductor silicon wafer manufacturing facility
- Review of workforce allocation in relation to restructuring of the manufacturing system

The Company is expecting to incur extraordinary loss of approximately 58.2 billion yen on a consolidated basis as business restructuring expenses in relation to the Plan. On a nonconsolidated base, the Company is expecting to incur extraordinary loss of approximately 34.8 billion yen in relation to the Plan as well as extraordinary loss of approximately 45.4 billion yen as an impairment loss due to the decrease in the substantial economic value of shares of consolidated subsidiaries including SUMCO TECHXIV.

The Company has also decided on reversal of deferred tax assets of 27.3 billion yen after considering uncertainties in the market environment, which will result in a sharp decrease in its equity capital.

In the light of such financial conditions, the Company decided to request companies including Sumitomo Metal Industries and Mitsubishi Materials, major shareholders of the Company, for their subscription of up to 45.0 billion yen of Preferred Shares where the Company’s major shareholders above will subscribe 15.0 billion yen respectively, as it would help the Company to maintain and increase the shareholder value in the long-term through reinforcement of the

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financial base and enhancement of relationships with the customers. The Company will continue to strive to meet the expectations of the shareholders and business partners through the execution of the Plan to enhance profitability and strengthening financial base through the contemplated equity financing.

As it will discuss specific terms and conditions of the Preferred Shares with the related parties including Sumitomo Metal Industries and Mitsubishi Materials going forward, the Company will take deep consideration in existing shareholders' concern on potential dilution. Once the details of terms and conditions such as total issue price are determined, the Company will announce in a timely manner.

2. Overview of Preferred Shares

(1) Method of Issuance	Third Party Allotment
(2) Type of Shares	Preferred Shares
(3) Total Issue Price	Up to 45.0 Billion Yen
(4) Expected Investors	Including Sumitomo Metal Industries, Ltd. and Mitsubishi Materials Corporation
(5) Schedule	Early March, 2012: Board resolution, Execution of definitive agreement, Submission of extraordinary report ⁽¹⁾ Late April, 2012: Date of the 13 th annual shareholders' meeting Early May, 2012: Issuance of the Preferred Shares (subject to resolution at the 13 th annual shareholders' meeting)

Note. 1

The Company plans to make the terms and conditions of the Preferred Shares not to contain any options which the Company or the holders may exercise at its sole discretion to issue or acquire the shares of common stock of the Company within short period as set forth in Section CIII (1)④ of the guideline regarding corporate disclosure granted by the FSA of Japan and will not submit the registration statement for the Preferred Shares pursuant to the Financial Instruments and Exchange Law of Japan.

* Contents of the overview stated above may be changed due to the result of future consultation.

3. Overview of Expected Investors

(1) Sumitomo Metal Industries, Ltd. (as of the end of September 2011)

(1) Company name	Sumitomo Metal Industries, Ltd.
(2) Head office	5-33, Kitahama 4-chome, Chuo-ku, Osaka
(3) Representative	Hiroshi Tomono Representative Director and President
(4) Business	1. Steelmaking and steel fabrication

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	(Manufacture and sale of iron and steel) 2. New materials 3. Civil engineering, construction, plant 4. Electric component 5. Electric power supply 6. System solutions
(5) Capital	262,072 million yen
(6) Date of establishment	July 1, 1949
(7) Number of outstanding shares	4,805,974,238 shares
(8) Date of fiscal year end	March 31
(9) Number of employees	22,597 (consolidated basis, as of March 31, 2011)
(10) Major customers	Sumitomo Corporation Sumikin Bussan Corporation
(11) Primary banks	Sumitomo Mitsui Banking Corporation The Sumitomo Trust and Banking Co., Ltd.
(12) Major shareholders and ownership percentage	Sumitomo Corporation 9.54%
	Nippon Steel Corporation 9.40%
	Japan Trustee Services Bank, Ltd. (account in trust) 4.01%
	The Master Trust Bank of Japan, Ltd. (account in trust) 2.91%
	Kobe Steel, Ltd. 2.34%
	Japan Trustee Services Bank, Ltd. (Sumitomo Mitsui Banking Corporation retirement benefit trust account re-entrusted by The Sumitomo Trust and Banking Co., Ltd.) 1.88%
	Nippon Life Insurance Company 1.85%
	SSBT OD05 Omnibus Account Treaty Clients 1.52%
	Japan Trustee Services Bank, Ltd., The Sumitomo Trust and Banking Corporation retirement benefit trust 1.23%
	NT RE GOVT OF SPORE INVT CORP P.LTD 1.19%
(13) Relationship with SUMCO Corporation	
Capital relationship	Sumitomo Metal Industries, Ltd. holds 71,700,000 common stocks of the Company
Personnel relationship	Kenji Takashi, Director of the Company serves as Managing Executive Officer of Sumitomo Metal Industries, Ltd. and Kitaro Yoshida, Auditor of the Company serves as Standing Corporate Auditor of Sumitomo Metal Industries, Ltd.
Business relationship	The Company buys major raw material of silicon wafer,

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	multi-polysilicon from OSAKA Titanium technologies Co., Ltd., an affiliated company of Sumitomo Metal Industries, Ltd. The Company also buys a part of equipment used in the process of semiconductor silicon wafer manufacturing from Sumitomo Metal Fine Technology Co., Ltd., a subsidiary of Sumitomo Metal Industries, Ltd.
Status as a Related Party	SUMCO Corporation is a equity method affiliate of Sumitomo Metal Industries, Ltd.

(14) Operating performance and financial status over the past three years

(unit: million yen, unless otherwise stated)

	Fiscal year ended March 2009	Fiscal year ended March 2010	Fiscal year ended March 2011
Consolidated net assets	904,371	879,209	818,080
Consolidated total assets	2,452,535	2,403,670	2,440,761
Consolidated net assets per share (yen)	184.92	178.87	165.41
Consolidated net sales	1,844,422	1,285,845	1,402,454
Consolidated operating profit	226,052	(928)	56,301
Consolidated ordinary profit	225,736	(36,634)	34,049
Consolidated net income	97,327	(49,772)	(7,144)
Consolidated net income per share (yen)	20.98	(10.74)	(1.54)
Cash dividend per share (yen)	10.0	5.0	3.5

(2) Mitsubishi Materials Corporation

(as of the end of September 2011)

(1) Company name	Mitsubishi Materials Corporation
(2) Head office	3-2, Otemachi 1-chome, Ohtemachi, Chiyoda-ku, Tokyo, Japan
(3) Representative	Hiroshi Yao President and Chief Executive Officer
(4) Business	Manufacture and sales of cement and cement secondary products; smelting, processing and sales of copper, gold, silver and other metals; manufacture and sales of cemented carbide and high-performance alloy products; manufacture and sales of electronic materials and components, electrical device products and polycrystalline silicon; manufacture and sales of aluminum beverage cans and milled aluminum products
(5) Capital	119,457 million yen

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(6) Date of establishment	April 1, 1950	
(7) Number of outstanding shares	1,314,895,351 shares	
(8) Date of fiscal year end	March 31	
(9) Number of employees	21,762 (consolidated basis, as of March 31, 2011)	
(10) Major customers	Users in Japan and overseas of the cement, copper, processed metals, electric components, electric materials, aluminum and other products	
(11) Primary banks	The Bank of Tokyo-Mitsubishi UFJ Ltd. Mitsubishi UFJ Trust and Banking Corp.	
(12) Major shareholders and ownership percentage	Japan Trustee Service Bank, Ltd. (Trust account)	5.87%
	The Master Trust Bank of Japan, Ltd. (Trust account)	5.01%
	The Meiji Yasuda Mutual Life Insurance Co.	2.36%
	SSBT OD05 OMNIBUS ACCOUNT -TREATY CLIENTS	2.06%
	The Bank of Tokyo-Mitsubishi UFJ Ltd.	1.87%
	Japan Trustee Service Bank, Ltd. (Trust account 9)	1.68%
	Nippon Life Insurance Company	1.50%
	Mitsubishi Heavy Industries, Ltd.	1.46%
	Mitsubishi UFJ Trust and Banking Corporation	1.37%
	Mitsubishi Estate Co., Ltd.	1.32%
(13) Relationship with SUMCO Corporation		
Capital relationship	Mitsubishi Materials Corporation holds 71,700,000 common stocks of the Company	
Personnel relationship	Mayuki Hashimoto, Director of the Company, serves as Executive Vice President of Mitsubishi Materials Corporation and Keisuke Yamanobe, Corporate Auditor of the Company, serves as Managing Director of Mitsubishi Materials Corporation	
Business relationship	The Company buys major raw material of silicon wafer, multi-polysilicon. The Company also buys a part of equipment used in the process of semiconductor silicon wafer manufacturing from Mitsubishi Materials Techno Corporation, a 100% subsidiary of Mitsubishi Materials Corporation	
Status as a Related Party	SUMCO Corporation is a equity method affiliate of Mitsubishi Materials Corporation	
(14) Operating performance and financial status over the past three years (unit: million yen, unless otherwise stated)		

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	Fiscal year ended March 2009	Fiscal year ended March 2010	Fiscal year ended March 2011
Consolidated net assets	421,934	399,095	402,868
Consolidated total assets	1,732,003	1,826,420	1,837,405
Consolidated net assets per share (yen)	287.44	259.93	262.38
Consolidated net sales	1,424,114	1,119,448	1,333,992
Consolidated operating profit	35,134	12,680	57,290
Consolidated ordinary profit	40,046	(9,541)	56,425
Consolidated net income	6,106	(66,555)	14,274
Consolidated net income per share (yen)	4.81	(52.34)	10.88
Cash dividend per share (yen)	4.00	0.00	2.00

The Company will announce the investors including Sumitomo Metal Industries and Mitsubishi Materials when decided.

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